



# AO4405, AO4405L (Green Product) P-Channel Enhancement Mode Field Effect Transistor

# **General Description**

The AO4405 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use as a load switch or in PWM applications. AO4405L( Green Product ) is offered in a lead-free package.

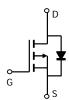
## **Features**

 $V_{DS}(V) = -30V$  $I_{D} = -6.0A$ 

 $R_{DS(ON)}$  < 50m $\Omega$  ( $V_{GS}$  = -10V)

 $R_{DS(ON)}$  < 85m $\Omega$  (V<sub>GS</sub> = -4.5V)





Absolute Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		$V_{DS}$	-30	V			
Gate-Source Voltage		$V_{GS}$	±20	V			
Continuous Drain	T <sub>A</sub> =25°C		-6.0				
Current <sup>A</sup>	T <sub>A</sub> =70°C	I <sub>D</sub>	-5.1	Α			
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	-30				
	T <sub>A</sub> =25°C	В	3	W			
Power Dissipation A	T <sub>A</sub> =70°C	$-P_D$	2.1	] vv			
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C			

Thermal Characteristics								
Parameter	Symbol	Тур	Units					
Maximum Junction-to-Ambient <sup>A</sup>	t ≤ 10s	ь	31	40	°C/W			
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	59	75	°C/W			
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{ heta JL}$	16	24	°C/W			

#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units	
STATIC PARAMETERS								
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D$ =-250 $\mu$ A, $V_{GS}$ =0V		-30			V	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ =-24V, $V_{GS}$ =0V				-1	μА	
			T <sub>J</sub> =55°C			-5		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ =±20V				±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_D=-250\mu A$		-1	-1.8	-3	V	
$I_{D(ON)}$	On state drain current	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-5V		-30			Α	
	Static Drain-Source On-Resistance	$V_{GS}$ =-10V, $I_D$ =6A			40	50	mΩ	
$R_{DS(ON)}$			T <sub>J</sub> =125°C		55	70	1115.2	
		$V_{GS}$ =-4.5V, $I_{D}$ =-4A		65	85	mΩ		
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-6A		6	9.5		S	
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =-1A,V <sub>GS</sub> =0V			-0.78	-1	V	
Is	Maximum Body-Diode Continuous Current					-4.2	Α	
DYNAMIC	PARAMETERS							
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =-15V, f=1MHz			700	840	pF	
C <sub>oss</sub>	Output Capacitance				112		pF	
$C_{rss}$	Reverse Transfer Capacitance				78		pF	
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz			10	15	Ω	
SWITCHI	NG PARAMETERS							
Q <sub>g</sub> (10V)	Total Gate Charge (10V)	- -V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-6A			14.7	18	nC	
Q <sub>g</sub> (4.5V)	Total Gate Charge (4.5V)				7.6		nC	
$Q_{gs}$	Gate Source Charge				2		nC	
$Q_{gd}$	Gate Drain Charge				3.8		nC	
$t_{D(on)}$	Turn-On DelayTime				8.6		ns	
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =-10V, $V_{DS}$ =-15V, $R_L$ =2.5 $\Omega$ , $R_{GEN}$ =3 $\Omega$			5		ns	
$t_{D(off)}$	Turn-Off DelayTime				28.2		ns	
t <sub>f</sub>	Turn-Off Fall Time				13.5		ns	
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =-6A, dI/dt=100A/μs			24	30	ns	
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =-6A, dI/dt=100A/μs			14.7		nC	

A: The value of  $R_{\theta JA}$  is measured with the device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the  $\bowtie$  10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead  $R_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using  $80\mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in  $^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$ =25°C. The SOA curve provides a single pulse rating.

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

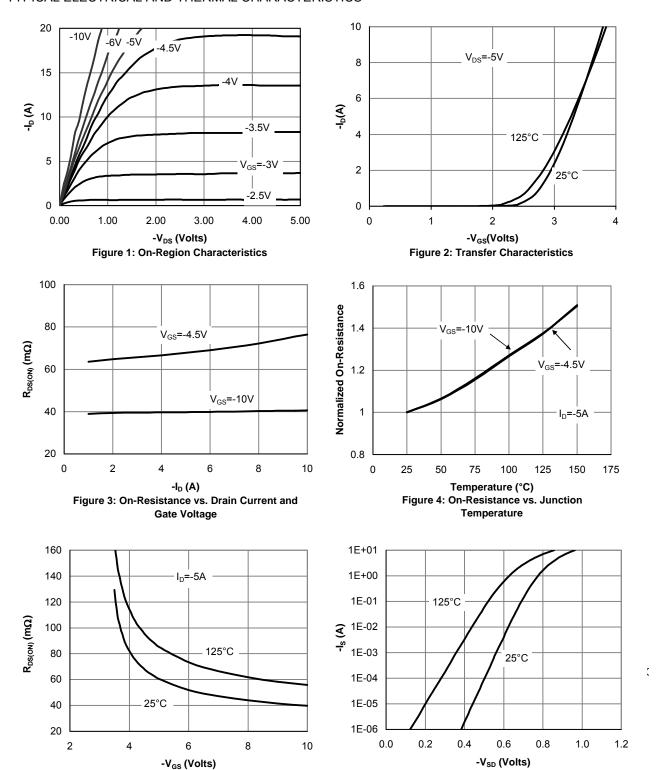


Figure 6: Body-Diode Characteristics

Figure 5: On-Resistance vs. Gate-Source Voltage

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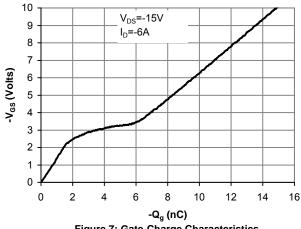


Figure 7: Gate-Charge Characteristics

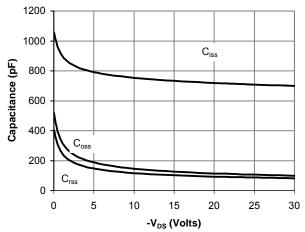


Figure 8: Capacitance Characteristics

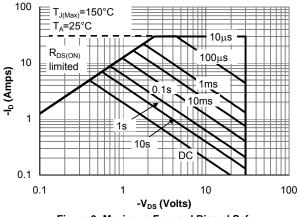


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

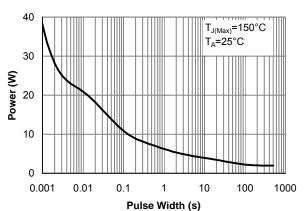


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

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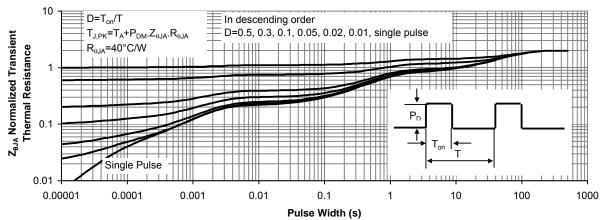


Figure 11: Normalized Maximum Transient Thermal Impedance